



Optimum power handling
Low on-state and switching losses
Designed for traction and industrial applications

Phase Control Stud Thyristor Type T171-320-16

Mean on-state current						I _{TAV}		320 A									
Repetitive peak off-state voltage*						V _{DRM}		100÷1600 V									
Repetitive peak reverse voltage*						V _{RRM}											
Turn-off time						t _q		125 μs									
V _{DRM} , V _{RRM} , V	100	200	300	400	500	600	700	800	900	1000	1100	1200	1300	1400	1500	1600	
Voltage code	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	
T _j , °C	-60÷125																

* 1800 V – Voltage class on demand

MAXIMUM ALLOWABLE RATINGS

Symbols and parameters			Units	Values	Test conditions	
ON-STATE						
I _{TAV}	Mean on-state current	A		320 355	T _c = 90 °C; T _c = 85 °C; 180° half-sine wave; 50 Hz	
I _{TRMS}	RMS on-state current	A		502	T _c = 90 °C; 180° half-sine wave; 50 Hz	
I _{TSM}	Surge on-state current	kA	10.0 12.0	T _j =T _j max T _j =25 °C	180° half-sine wave; 50 Hz (t _p =10 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs	
			11.0 13.0	T _j =T _j max T _j =25 °C	180° half-sine wave; 60 Hz (t _p =8.3 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs	
I ² t	Safety factor	A ² s·10 ³	500 720	T _j =T _j max T _j =25 °C	180° half-sine wave; 50 Hz (t _p =10 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs	
			500 700	T _j =T _j max T _j =25 °C	180° half-sine wave; 60 Hz (t _p =8.3 ms); single pulse; V _D =V _R =0 V; Gate pulse: I _G =2 A; t _{GP} =50 μs; di _G /dt≥1 A/μs	
BLOCKING						
V _{DRM} , V _{RRM}	Repetitive peak off-state and Repetitive peak reverse voltages	V	100÷1600	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz; Gate open		
V _{DSM} , V _{RSM}	Non-repetitive peak off-state and Non-repetitive peak reverse voltages	V	110÷1700	T _{j min} < T _j <T _{j max} ; 180° half-sine wave; 50 Hz;single pulse; Gate open		
V _D , V _R	Direct off-state and Direct reverse voltages	V	0.75·V _{DRM} 0.75·V _{RRM}	T _j =T _j max; Gate open		

TRIGGERING				
I_{FGM}	Peak forward gate current	A	6	$T_j = T_{j \max}$
V_{RGM}	Peak reverse gate voltage	V	5	
P_G	Gate power dissipation	W	3	$T_j = T_{j \max}$ for DC gate current
SWITCHING				
$(di_T/dt)_{crit}$	Critical rate of rise of on-state current non-repetitive ($f=1$ Hz)	A/ μ s	320	$T_j = T_{j \max}; V_D = 0.67 \cdot V_{DRM}; I_{TM} = 2 I_{TAV};$ Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s
THERMAL				
T_{stg}	Storage temperature	°C	-60÷125	
T_j	Operating junction temperature	°C	-60÷125	
MECHANICAL				
M	Tightening torque	Nm	25÷35	
a	Acceleration	m/s ²	100	

CHARACTERISTICS

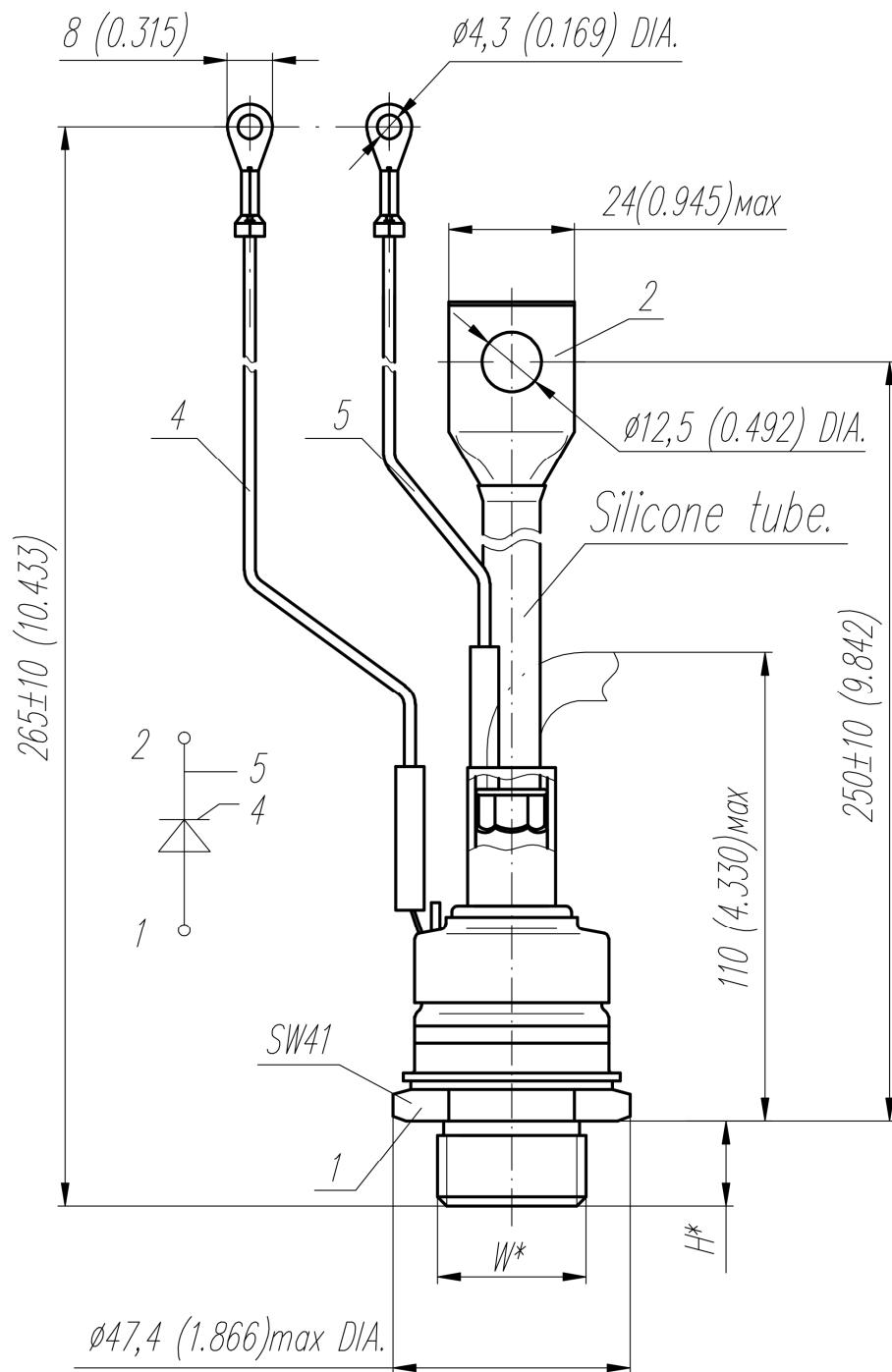
Symbols and parameters		Units	Values	Conditions		
ON-STATE						
V_{TM}	Peak on-state voltage, max	V	1.60	$T_j = 25$ °C; $I_{TM} = 1005$ A		
$V_{T(TO)}$	On-state threshold voltage, max	V	0.95	$T_j = T_{j \max};$ $0.5 \pi I_{TAV} < I_T < 1.5 \pi I_{TAV}$		
r_T	On-state slope resistance, max	$m\Omega$	0.510			
I_L	Latching current, max	mA	700	$T_j = 25$ °C; $V_D = 12$ V; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s		
I_H	Holding current, max	mA	300	$T_j = 25$ °C; $V_D = 12$ V; Gate open		
BLOCKING						
I_{DRM}, I_{RRM}	Repetitive peak off-state and Repetitive peak reverse currents, max	mA	70	$T_j = T_{j \max};$ $V_D = V_{DRM}; V_R = V_{RRM}$		
$(dv_D/dt)_{crit}$	Critical rate of rise of off-state voltage ¹⁾ , min	V/ μ s	1000	$T_j = T_{j \max};$ $V_D = 0.67 V_{DRM}$; Gate open		
TRIGGERING						
V_{GT}	Gate trigger direct voltage, max	V	4.00 2.50 2.00	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$	$V_D = 12$ V; $I_D = 3$ A; Direct gate current	
I_{GT}	Gate trigger direct current, max	mA	400 250 200	$T_j = T_{j \min}$ $T_j = 25$ °C $T_j = T_{j \max}$		
V_{GD}	Gate non-trigger direct voltage, min	V	0.25	$T_j = T_{j \max};$ $V_D = 0.67 V_{DRM};$ Direct gate current		
I_{GD}	Gate non-trigger direct current, min	mA	10.00			
SWITCHING						
t_{gd}	Delay time	μ s	2.00	$T_j = 25$ °C; $V_D = 0.4 V_{DRM}$; $I_{TM} = I_{TAV}$; Gate pulse: $I_G = 2$ A; $t_{GP} = 50 \mu$ s; $di_G/dt \geq 1$ A/ μ s		
t_q	Turn-off time ²⁾ , max	μ s	125	$dv_D/dt = 50$ V/ μ s; $T_j = T_{j \max}$; $I_{TM} = I_{TAV}$; $di_R/dt = -10$ A/ μ s; $V_R = 100$ V; $V_D = 0.67 V_{DRM}$;		

THERMAL				
R _{thjc}	Thermal resistance, junction to case, max	°C/W	0.0800	Direct current
MECHANICAL				
w	Weight, typ	g	440	
D _s	Surface creepage distance	mm (inch)	12.40 (4.882)	
D _a	Air strike distance	mm (inch)	12.40 (4.882)	

PART NUMBERING GUIDE				
T	171	320	16	N
1	2	3	4	5
1. Phase Control Thyristor				
2. Design version				
3. Mean on-state current, A				
4. Voltage code				
5. Ambient conditions: N – normal; T – tropical				

OVERALL DIMENSIONS

Package type: T.SB1



Type of screw	W	H
Metric Screw Type C	M24x1,5 – 8g	19
Metric Screw Type B(upon request)	M20x1,5 – 8g	15

Polarity	Example of code designation	Reference designation	Colors		
			Anode	Cathode	Gate
Anode to stud	T171-320-16		-	Red tube	White

All dimensions in millimeters (inches)

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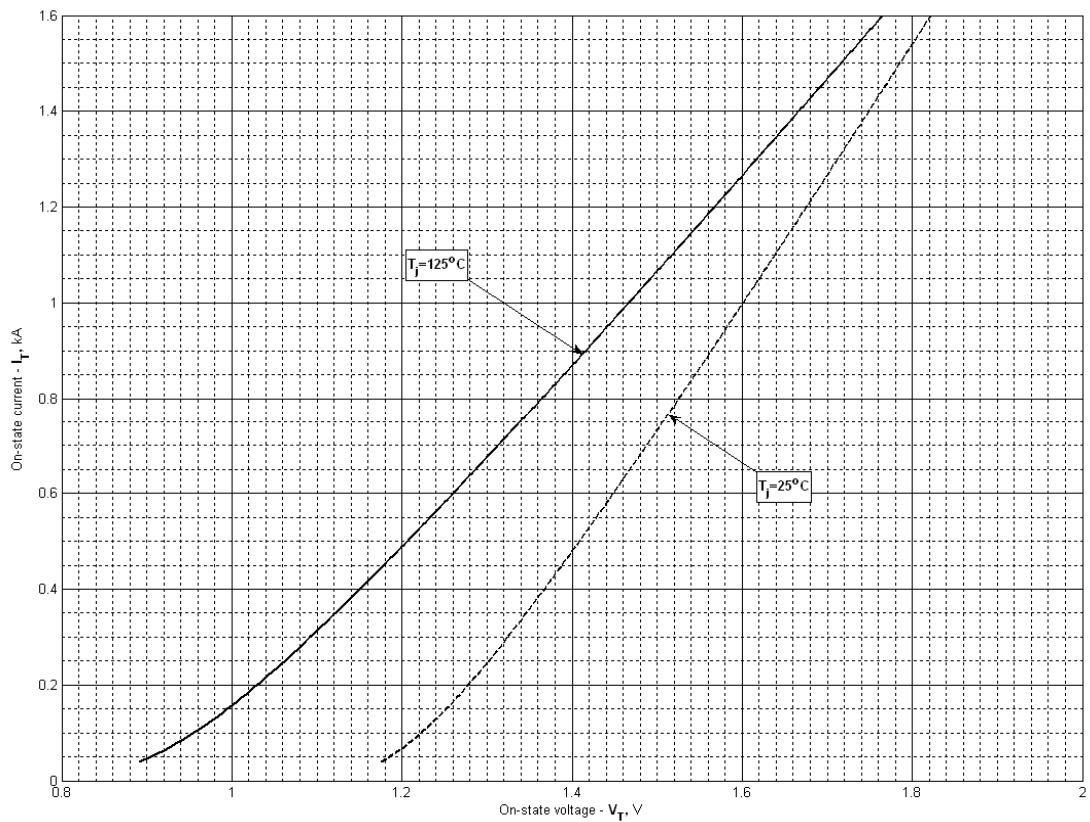


Fig 1 – On-state characteristics of Limit device

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

Coefficients for max curves		
	T _j = 25°C	T _j = T _{j max}
A	1.108422	0.802026
B	0.323295	0.438347
C	-0.224382	-0.299678
D	0.324688	0.433643

On-state characteristic model (see Fig. 1)

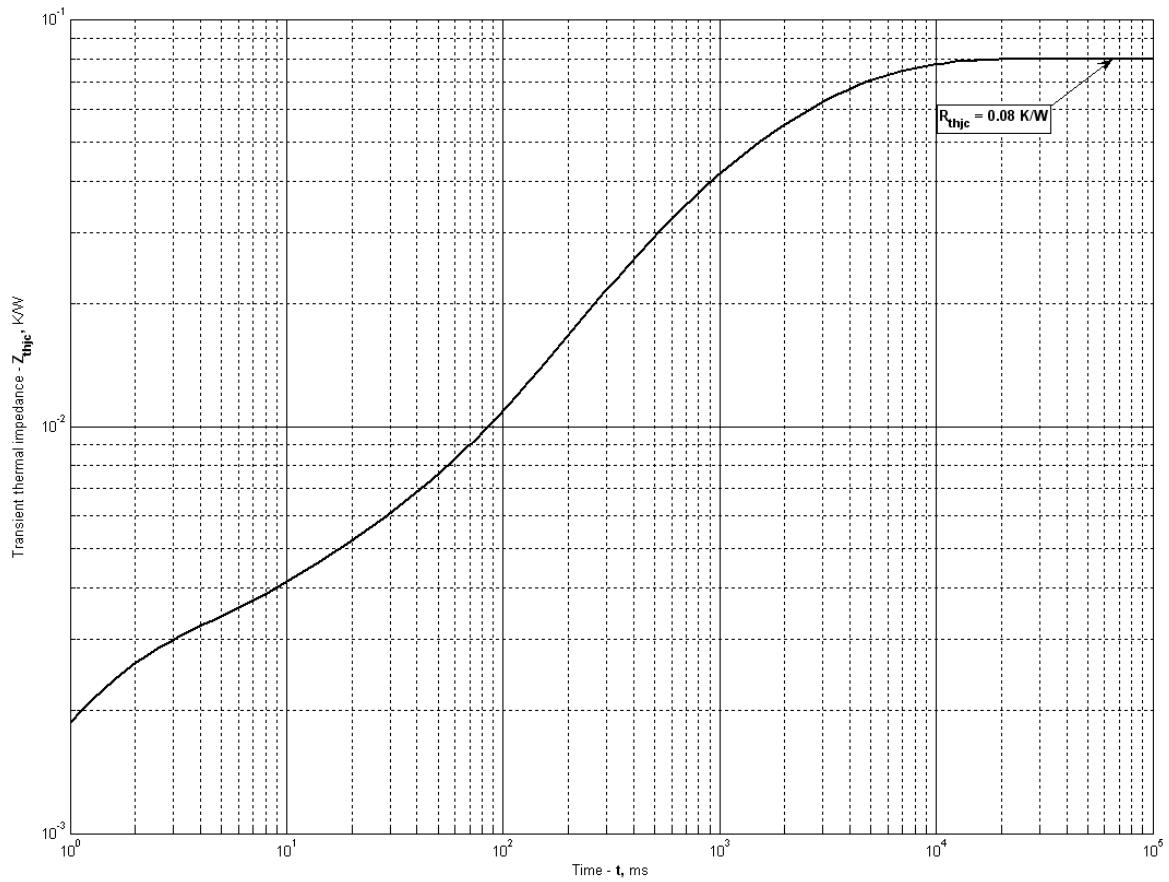


Fig 2 – Transient thermal impedance

Analytical function for Transient thermal impedance junction to case Z_{thjc} for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left(1 - e^{-\frac{t}{\tau_i}} \right)$$

Where $i = 1$ to n , n is the number of terms in the series.

t = Duration of heating pulse in seconds.

Z_{thjc} = Thermal resistance at time t .

R_i = Amplitude of p_{th} term.

τ_i = Time constant of r_{th} term.

DC

i	1	2	3	4	5	6
R_i , K/W	0.01836	0.02733	0.01495	0.001445	0.002488	0.01543
τ_i , s	4.627	2.249	0.3406	0.01043	0.0009112	0.9081

Transient thermal impedance junction to case Z_{thjc} model (see Fig. 2)

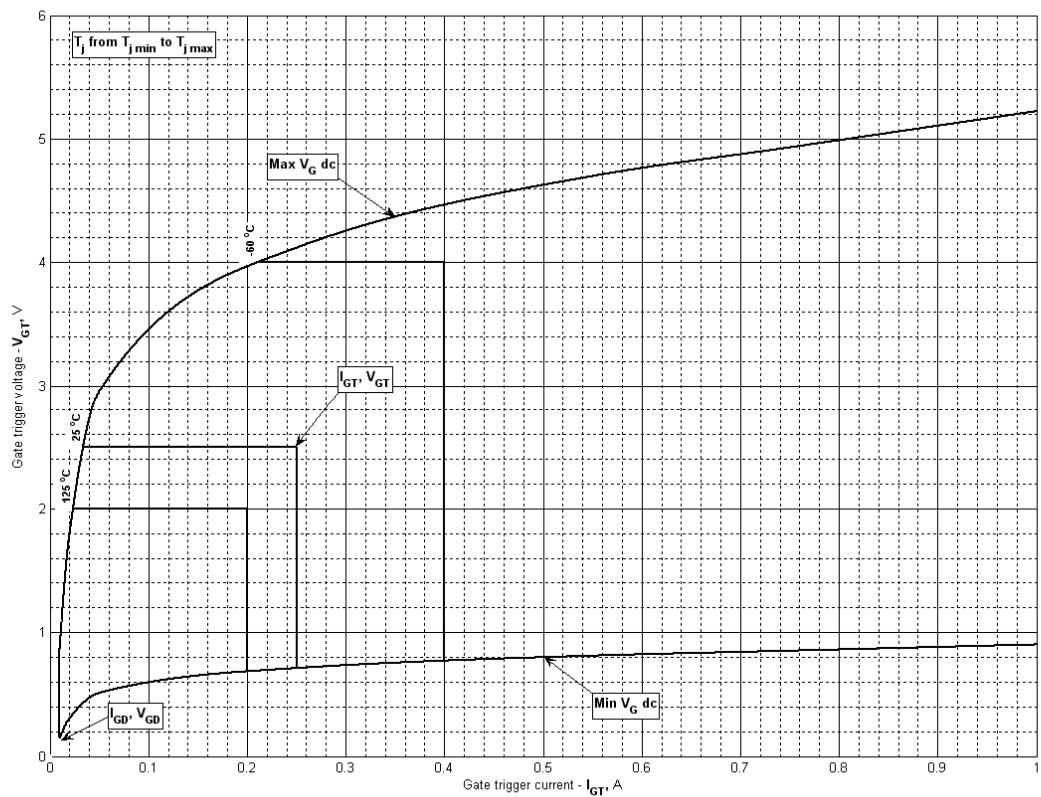


Fig 3 – Gate characteristics – Trigger limits

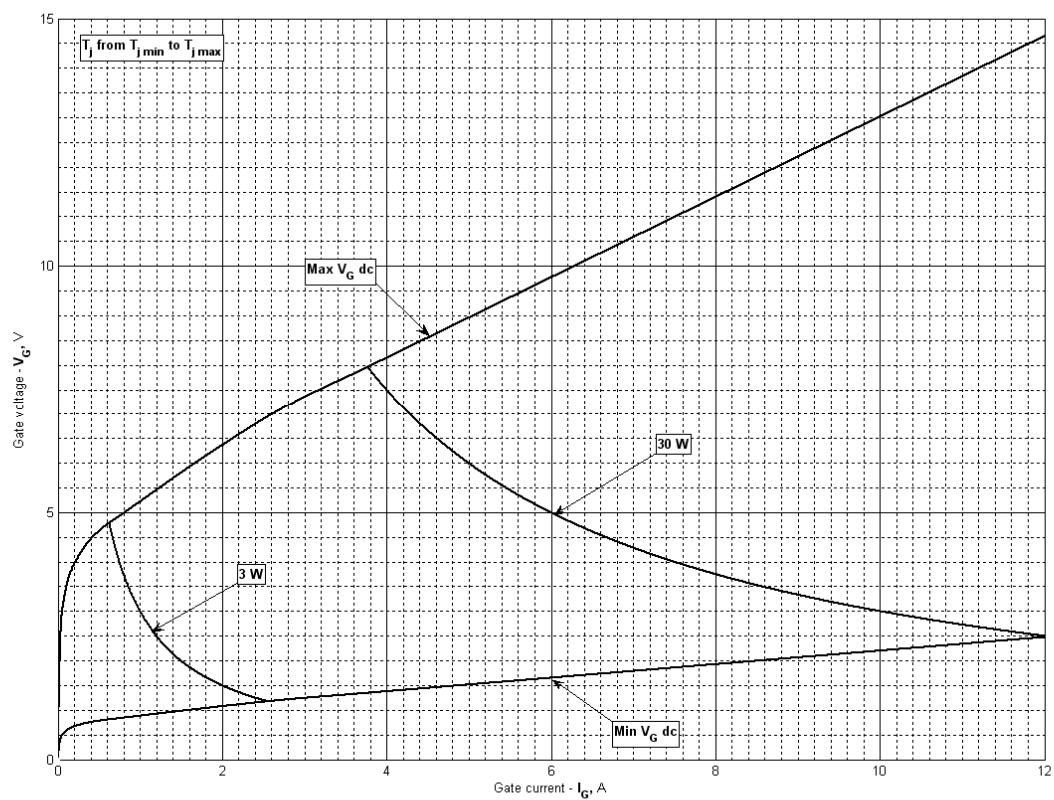


Fig 4 - Gate characteristics –Power curves

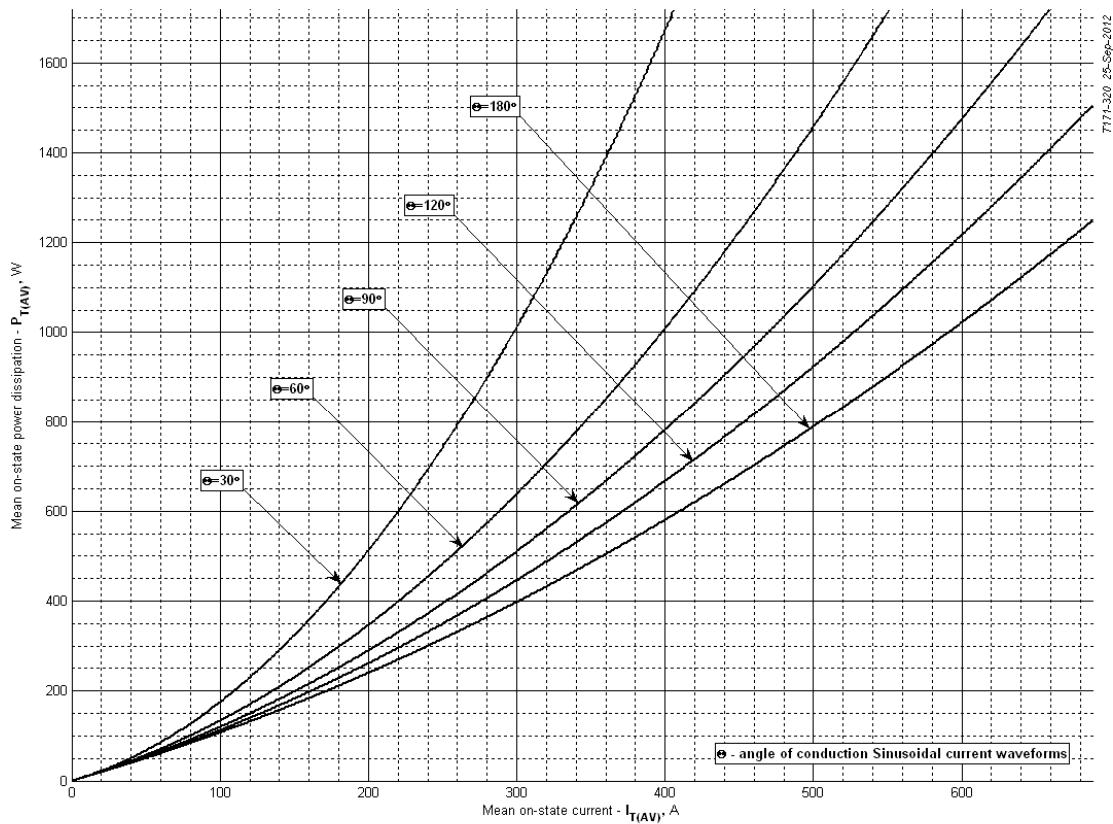


Fig 5 – On-state power loss (sinusoidal current waveforms)

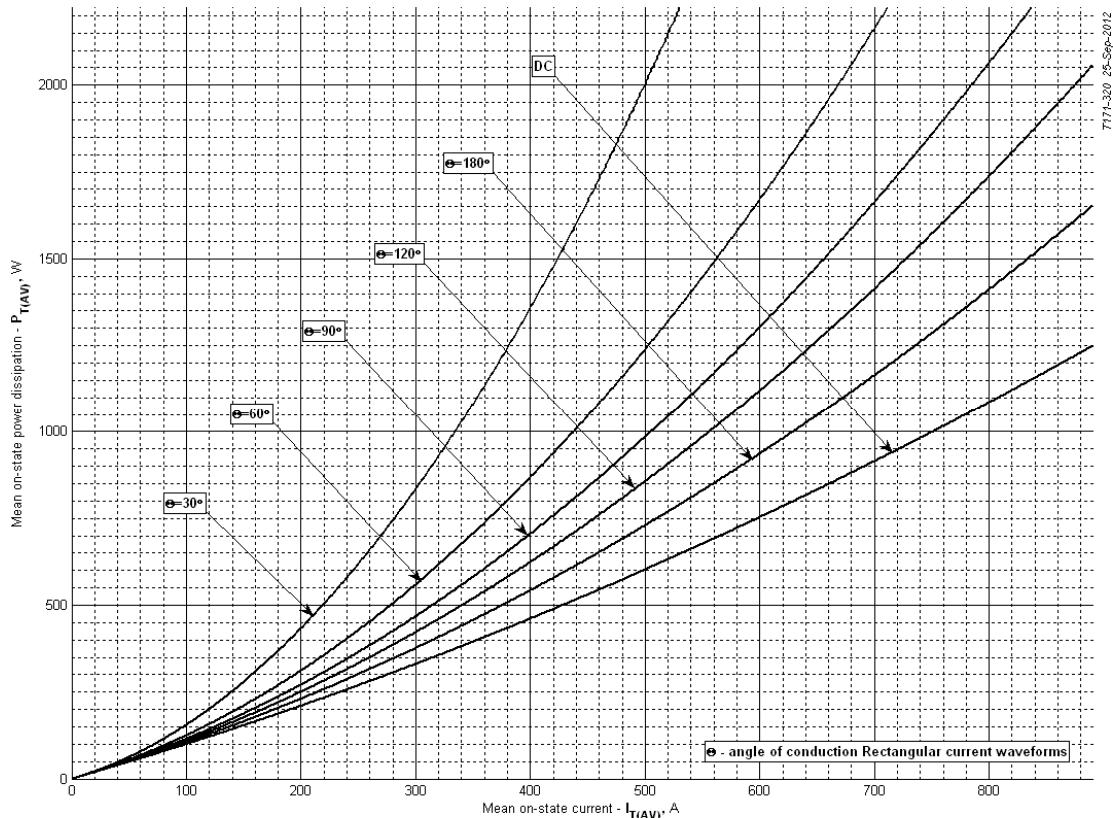


Fig 6 – On-state power loss (rectangular current waveforms)

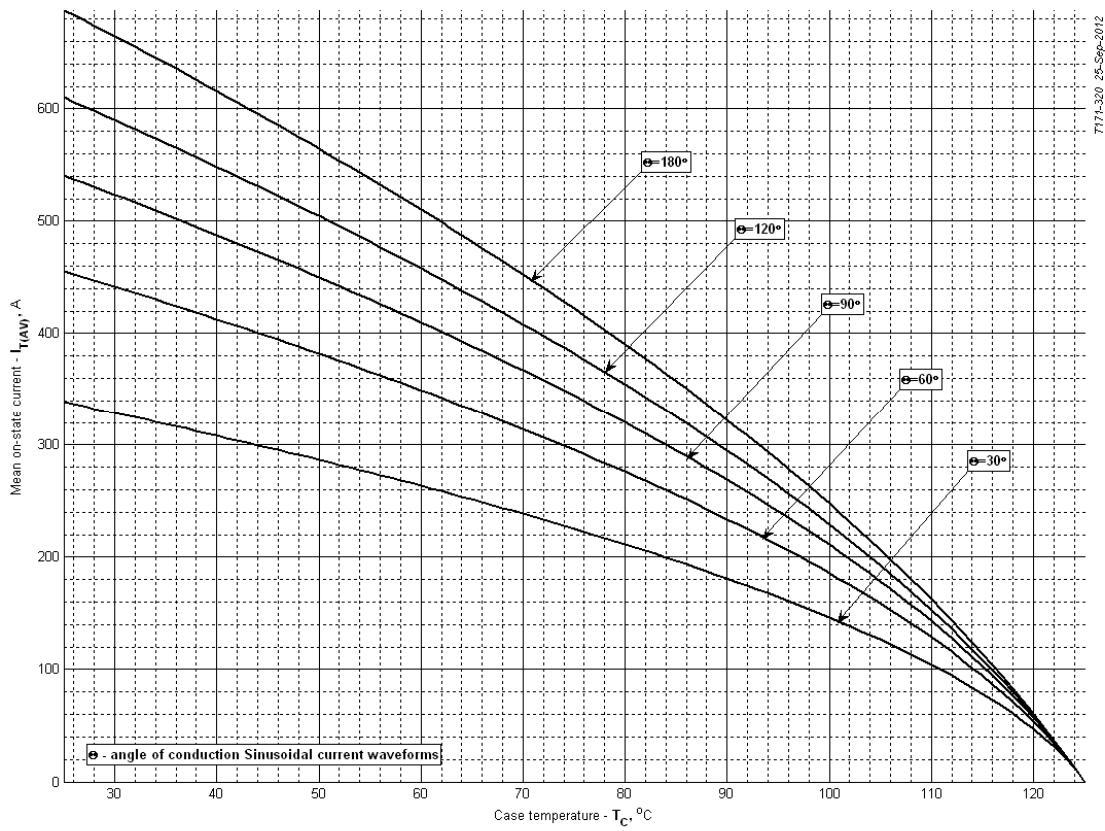


Fig 7 – Maximum case temperature DSC (sinusoidal current waveforms)

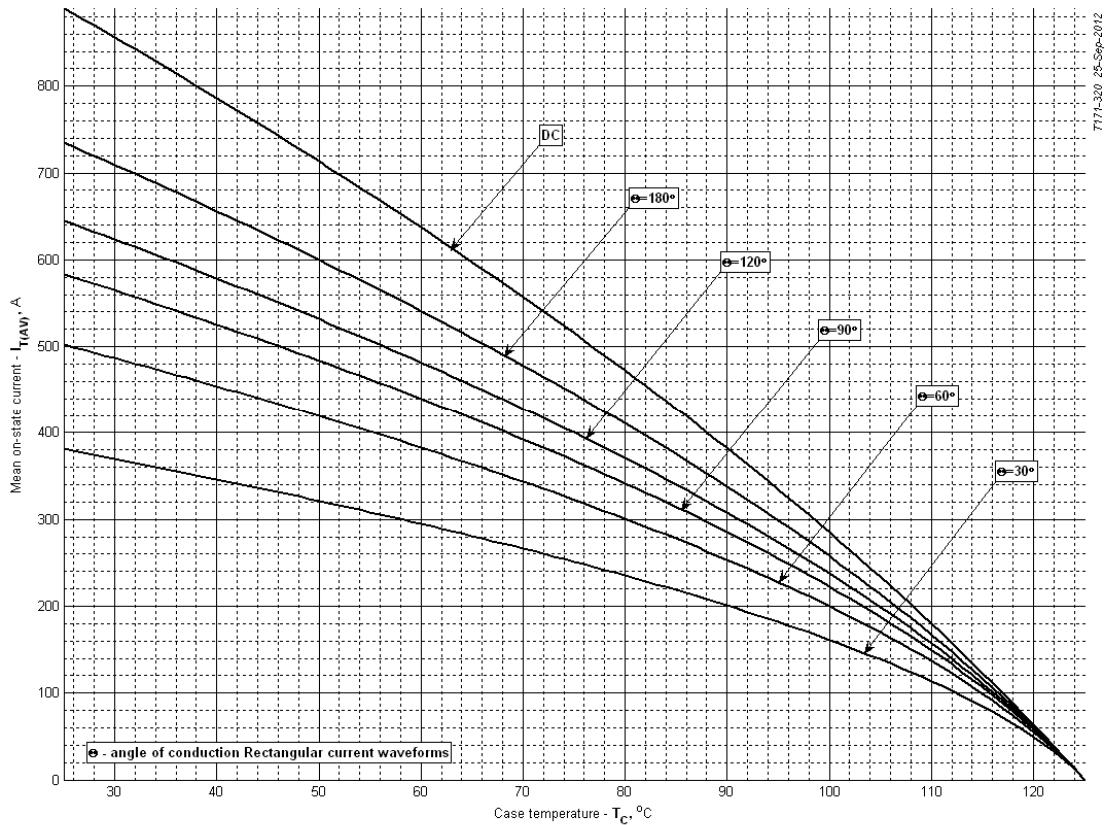


Fig 8 – Maximum case temperature DSC (rectangular current waveforms)

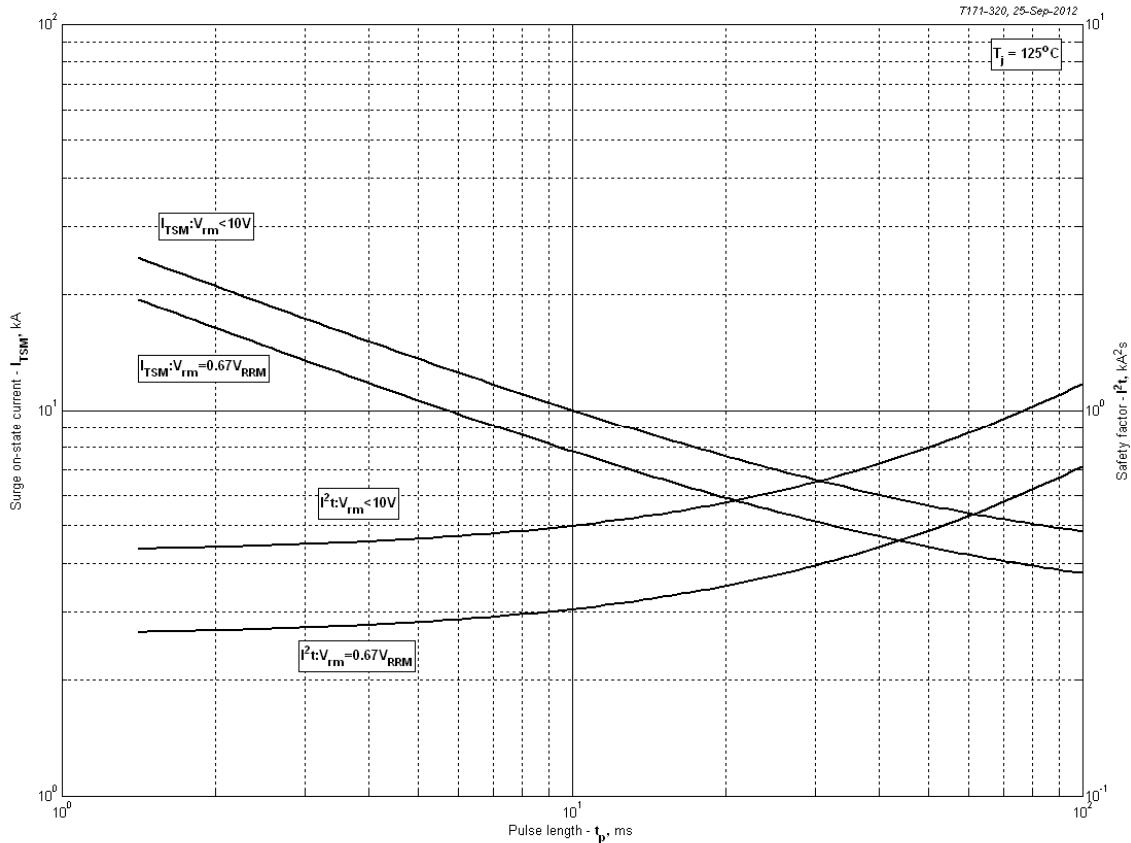


Fig 9 – Maximum surge and I^2t ratings

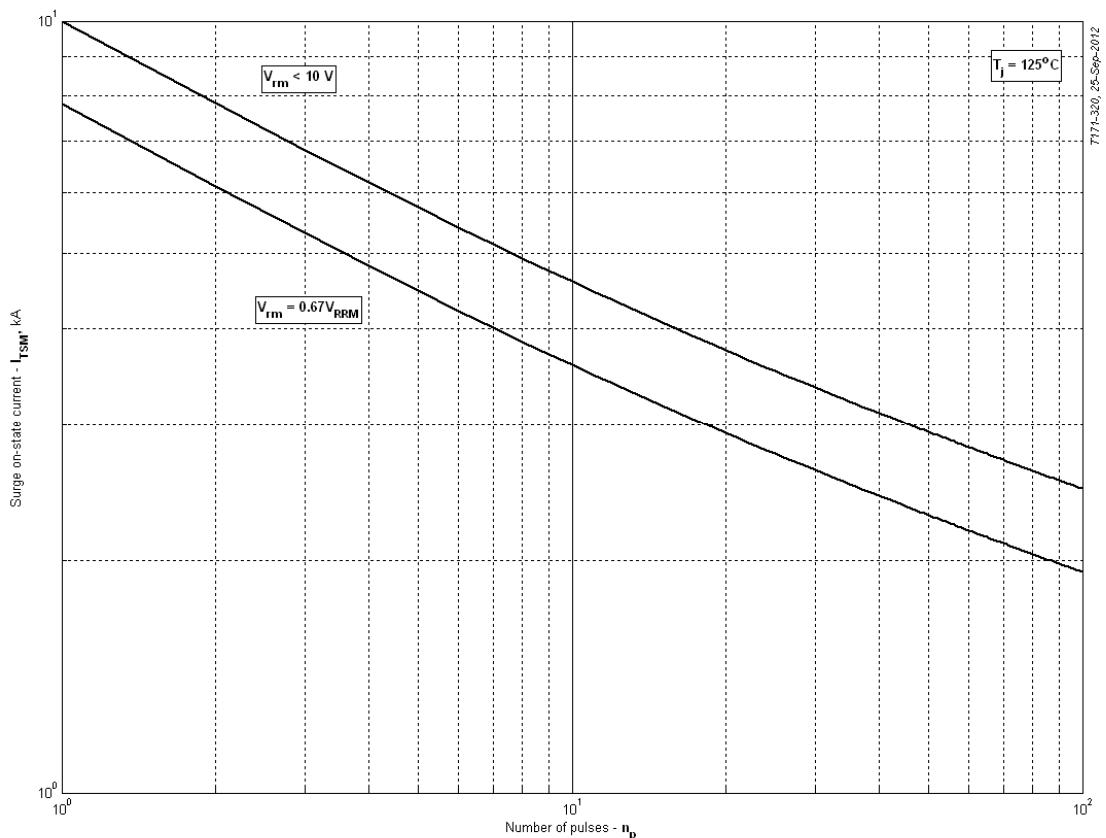


Fig 10 – Maximum surge ratings